STARPOWER

SEMICONDUCTOR™

IGBT

GD75CUT120C1S

Molding Type Module

1200V/75A chopper in one-package

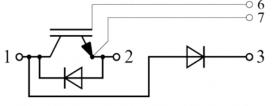
General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low V_{CE(sat)} trench IGBT technology
- Low switching losses
- 10µs short circuit capability
- V_{CE(sat)} with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

Symbol	Description	GD75CUT120C1S	Units
V_{CES}	Collector-Emitter Voltage	1200	V
$ m V_{GES}$	Gate-Emitter Voltage	±20	V
T	Collector Current @ T _C =25°C	150	Δ.
I_{C}	@ T _C =80°C	75	A
I _{CM(1)}	Pulsed Collector Current t _p =1ms	150	A
I_{F}	Diode Continuous Forward Current	75	A
I_{FM}	Diode Maximum Forward Current	150	A
P_{D}	Maximum Power Dissipation @ T _j =150℃	568	W
T_{j}	Maximum Junction Temperature	150	$^{\circ}\!\mathbb{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\!\mathbb{C}$
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	2500	V
Mounting	Power Terminal Screw:M5	2.5 to 5.0	N m
Torque	Mounting Screw:M6	3.0 to 5.0	N.m

Notes:

Electrical Characteristics of IGBT T_C =25 $^{\circ}$ C unless otherwise noted

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{(BR)CES}	Collector-Emitter	T _i =25°C	1200			V
	Breakdown Voltage	1, 25 0				v
I_{CES}	Collector Cut-Off Current	$V_{\text{CE}}=V_{\text{CES}}, V_{\text{GE}}=0V,$			5.0	A
		T _j =25℃				mA
I_{GES}	Gate-Emitter Leakage	$V_{GE}=V_{GES},V_{CE}=0V,$			400	nA
	Current	T _j =25℃			400	

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{\text{GE(th)}}$	Gate-Emitter Threshold	I_C =3.0mA, V_{CE} = V_{GE} ,	5.0	5.8	6.5	V
	Voltage	T _j =25℃	5.0			
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I_{C} =75A, V_{GE} =15V,		1.70	2.15	
		I_{C} =75A, V_{GE} =15V, T_{j} =25°C				V
		I_{C} =75A, V_{GE} =15V,		2.00		
		T _j =125℃				

⁽¹⁾ Repetitive rating: Pulse width limited by max. junction temperature

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
t _{d(on)}	Turn-On Delay Time			259		ns
t _r	Rise Time			30		ns
t _{d(off)}	Turn-Off Delay Time	V -(00VI -75A		420		ns
$\overline{t_{\mathrm{f}}}$	Fall Time	V_{CC} =600V, I_{C} =75A,		70		ns
Eon	Turn-On Switching	R_{G} =4.7 Ω , V_{GE} = \pm 15 V , T_{i} =25 $^{\circ}$ C		/		mJ
Lon	Loss			,		1113
E_{off}	Turn-Off Switching			/		mJ
Loff	Loss			/		1117
$t_{d(on)}$	Turn-On Delay Time			291		ns
t_r	Rise Time			49		ns
$t_{d(off)}$	Turn-Off Delay Time	V -600VI -75A		515		ns
$t_{\rm f}$	Fall Time	V_{CC} =600V, I_{C} =75A, R_{G} =4.7 Ω , V_{GE} = \pm 15V, T_{j} =125°C		90		ns
Eon	Turn-On Switching		6	6.99		mJ
Lon	Loss			0.99		
E_{off}	Turn-Off Switching			9.51		mJ
Loff	Loss			9.31		1113
Cies	Input Capacitance			5.35		nF
Coes	Output Capacitance	V_{CE} =25V,f=1MHz,		0.28		nF
C_{res}	Reverse Transfer	$V_{GE}=0V$		0.24		nF
Cres	Capacitance			0.24		ШГ
I_{SC}		$t_{S^{C}} \le 10 \mu s, V_{GE} = 15 V,$ $T_{j} = 125 ^{\circ}C, V_{CC} = 600 V,$				
	SC Data			300		A
		$V_{CEM} \leq 1200V$				
R_{Gint}	Internal Gate Resistance			10		Ω
L_{CE}	Stray Inductance				30	nН
D	Module Lead Resistance,	T _C =25°C		0.75		mΩ
R _{CC'+EE'}	Terminal to Chip	10-23				III 75

Electrical Characteristics of DIODE T_C=25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V_{F}	Diode Forward	I —75 A	T _j =25℃		1.78	2.18	V
	Voltage	$I_F=75A$	T _j =125℃		1.85]
Qr	December of Change		T _j =25℃		3.6		
	Recovered Charge	$I_F=75A$,	T _j =125℃		7.9		μС
I_{RM}	Peak Reverse	$V_R = 600V$,	T _j =25℃		63		Α
	Recovery Current	di/dt=-1550A/μs,	T _j =125℃		73		A
E _{rec}	Reverse Recovery	V _{GE} =-15V	T _j =25℃		2.21		I
	Energy		T _j =125℃		4.48		mJ

Thermal Characteristics

Symbol	Parameter		Max.	Units
$R_{\theta JC}$	Junction-to-Case (per IGBT)		0.22	K/W
$R_{\theta JC}$	Junction-to-Case (per DIODE)		0.34	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.05		K/W
Weight	Weight of Module	150		g

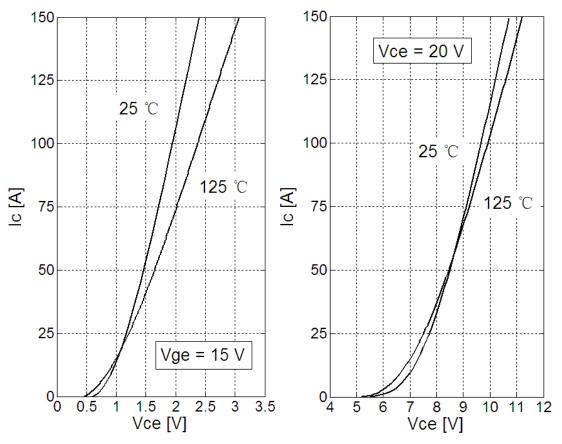


Fig 1. IGBT Typical Output Characteristics Fig 2. IGBT Typical Transfer Characteristics

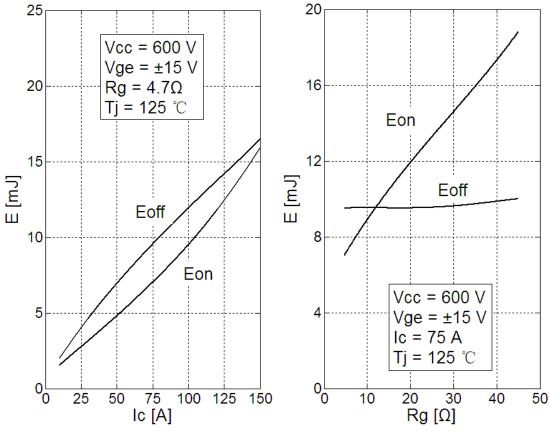


Fig 3. IGBT Switching Loss vs. I_C

Fig 4. IGBT Switching Loss vs. $R_{\rm G}\,$

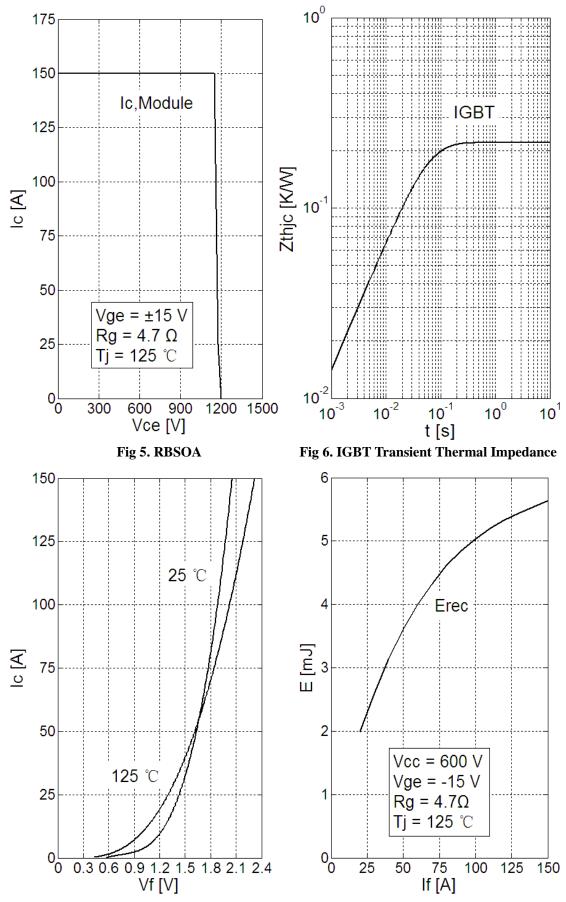


Fig 7. Diode Typical Forward Characteristics

Fig 8. Diode Switching Loss vs. $I_{\rm F}$

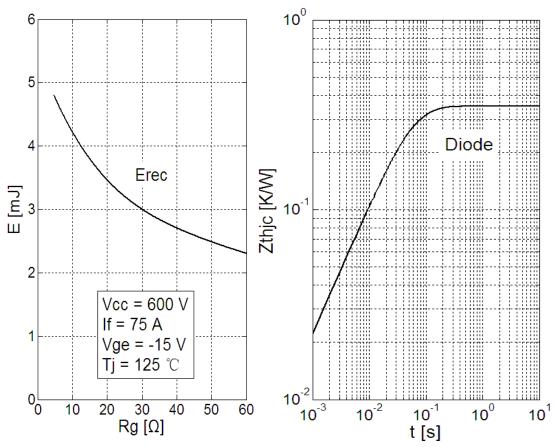
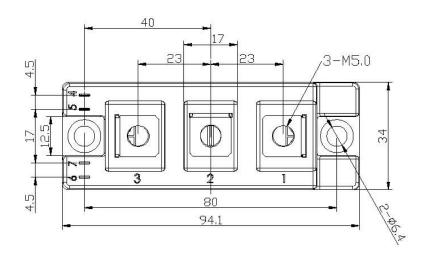


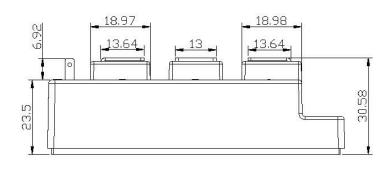
Fig 9. Diode Switching Loss vs. R_G

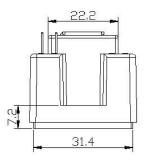
Fig 10. Diode Transient Thermal Impedance

Package Dimension

Dimensions in Millimeters







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